

HMC215LP4 / 215LP4E

v01.0111



GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 1.7 - 4.0 GHz

Typical Applications

The HMC215LP4 / HMC215LP4E is ideal for Wireless Infrastructure Applications:

- PCS / 3G Infrastructure
- Base Stations & Repeaters
- WiMAX & WiBro
- ISM & Fixed Wireless

Features

Input IP3: +25 dBm

Low Input LO Drive: +2 to +6 dBm

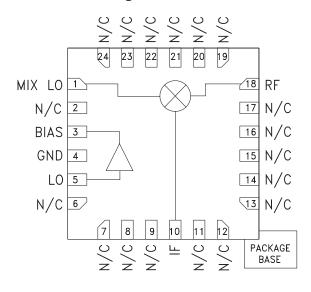
High LO to RF Isolation: 32 dB

Low Conversion Loss: 8 dB

Single Positive Supply: +5V @ 56 mA

24 Lead Ceramic 4x4mm SMT Package: 16mm²

Functional Diagram



General Description

The HMC215LP4 & HMC215LP4E are high linearity, double-balanced converter ICs that operate from 1.7 to 4.0 GHz and deliver a +25 dBm input third order intercept point. The LO amplifier output and high dynamic range mixer input are positioned so that an external LO filter can be placed in series be-tween them. The converter provides 32 dB of LO to RF isolation and is ideal for upconverter and down-converter applications. The IC operates from a single +5V supply consuming 56 mA of current and accepts a LO drive level of 2 to 6 dBm. The design requires no external baluns and supports IF frequencies between DC and 1 GHz. The HMC215LP4(E) is pin for pin compatible with the HMC552LP4(E), which operates from 1.6 to 3.0 GHz.

Electrical Specifications, $T_{\Delta} = +25^{\circ}\text{C}$, LO = +4 dBm, Vcc = +5V, IF = 100 MHz*

Parameter	Min.	Тур.	Max.	Units
Frequency Range, RF, LO		1.7 - 4.0		GHz
Frequency Range, IF		DC - 1.0		GHz
Conversion Loss		8.0	11	dB
Noise Figure (SSB)		8.5		dB
LO to RF Isolation	23	32		dB
LO to IF Isolation	10	20		dB
IP3 (Input)		25		dBm
1 dB Compression (Input)		17		dBm
LO Drive Input Level (Typical)	2 to 6		dBm	
Supply Current (Icc)		56	60	mA

^{*}Unless otherwise noted, all measurements performed as a downconverter, with low side LO and configured as shown in application circuit.

HMC215* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

COMPARABLE PARTS -

View a parametric search of comparable parts.

EVALUATION KITS

• HMC215LP4 Evaluation Board.

DOCUMENTATION

Data Sheet

• HMC215 Data Sheet

TOOLS AND SIMULATIONS

HMC215 S-Parameters

REFERENCE MATERIALS 🖵

Quality Documentation

- Package/Assembly Qualification Test Report: LP4, LP4B, LP4C, LP4K (QTR: 2013-00487 REV: 04)
- Package/Assembly Qualification Test Report: Plastic Encapsulated QFN (QTR: 05006 REV: 02)
- Semiconductor Qualification Test Report: MESFET-A (QTR: 2013-00244)

DESIGN RESOURCES 🖵

- HMC215 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

View all HMC215 EngineerZone Discussions.

SAMPLE AND BUY

Visit the product page to see pricing options.

TECHNICAL SUPPORT

Submit a technical question or find your regional support number.

DOCUMENT FEEDBACK 🖳

Submit feedback for this data sheet.

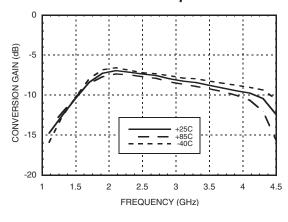
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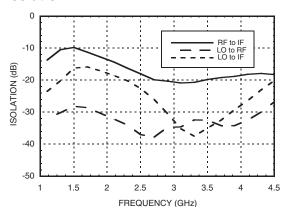


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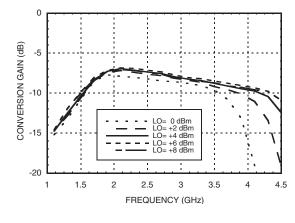
Conversion Gain vs. Temperature



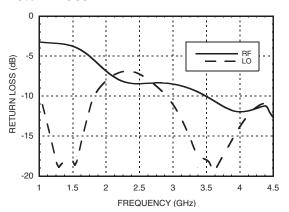
Isolation



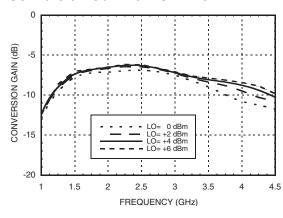
Conversion Gain vs. LO Drive



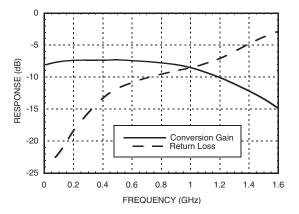
Return Loss



Upconverter Performance Conversion Gain vs. LO Drive



IF Bandwidth

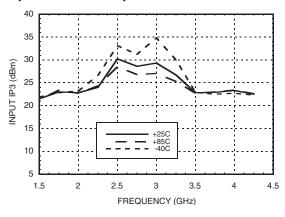




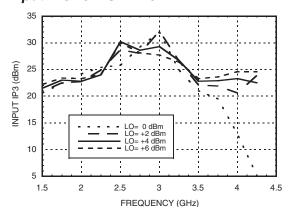


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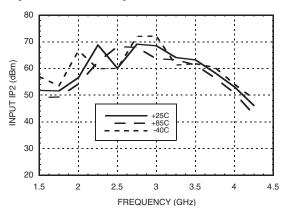
Input IP3 vs. Temperature



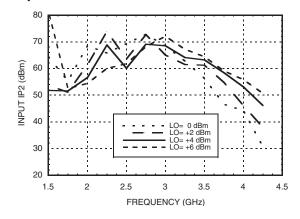
Input IP3 vs. LO Drive



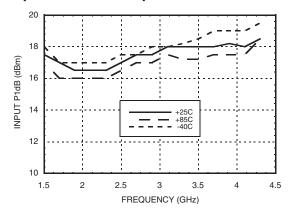
Input IP2 vs. Temperature



Input IP2 vs. LO Drive



Input P1dB vs. Temperature



MxN Spurious @ IF Port

	nLO				
mRF	0	1	2	3	4
0	xx	-4	10	14	32
1	5	0	22	37	49
2	78	66	60	63	93
3	83	97	92	80	80
4	103	101	106	105	101

RF Freq. = 1.9 GHz @ -10 dBm

LO Freq. = 1.8 GHz @ 4 dBm

All values in dBc relative to the IF power level.





GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER. 1.7 - 4.0 GHz

Harmonics of LO

	nLO Spur @ RF Port			
LO Freq. (GHz)	1	2	3	4
1.0	32	40	27	40
1.4	28	19	25	30
1.8	29	16	30	42
2.2	33	18	27	44
2.6	35	23	34	41
3.0	34	20	41	44
LO = 4 dBm				

All values in dBc below input LO level measured at RF port.



ELECTROSTATIC SENSITIVE DEVICE **OBSERVE HANDLING PRECAUTIONS**

Typical Supply Current

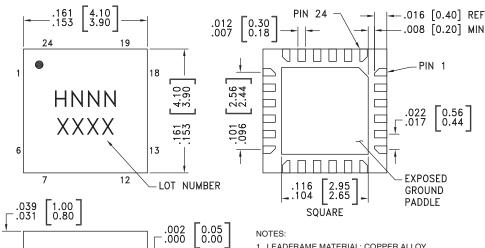
Vcc	Icc (mA)
+5.0	56 mA

Absolute Maximum Ratings

+22 dBm
+10 dBm
+7 Vdc
150°C
0.339 W
192 °C/W
-65 to +150°C
-40 to +85°C

Outline Drawing

BOTTOM VIEW



SEATING

PLANE

-C-

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM. PAD BURB HEIGHT SHALL BE 0.05mm MAXIMUM
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

.003[0.08]|C

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC215LP4	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H215 XXXX
HMC215LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	<u>H215</u> XXXX

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX



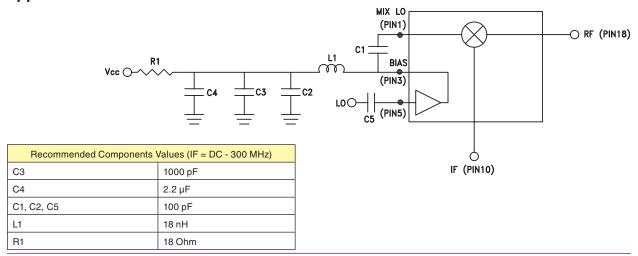


GaAs MMIC MIXER w/ INTEGRATED LO AMPLIFIER, 1.7 - 4.0 GHz

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	MIX LO	This pin is DC coupled and matched to 50 Ohms. An off chip DC blocking capacitor is required.	MIX LOO
2, 6 - 9, 11 - 17, 19 - 24	N/C	No connection. These pins may be connected to RF ground. Performance will not be affected.	
3	BIAS	Power supply for the LO amplifier. Three external bypass capacitors are recommended for optimum performance, as illustrated in the application circuit.	BIASO
4	GND	Backside of package has exposed metal ground paddle that must also be connected to ground.	⊖ GND =
5	LO	This pin is DC coupled and matched to 50 Ohms from 1.7 to 4.0 GHz. An off chip DC blocking capacitor is required.	LOO
10	IF	This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source/sink more than 18 mA of current or die non-function and possible die failure will result.	IF O-M
18	RF	This pin is DC coupled and matched to 50 Ohms.	RF O

Application Circuit



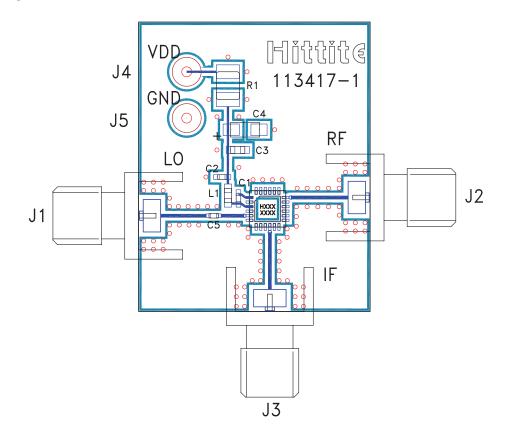
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RoHS√

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Evaluation PCB



List of Materials for Evaluation PCB 115820 [1]

Item	Description	
J1 - J3	PCB Mount SMA RF Connector	
J4, J5	DC Pin	
C1, C2, C5	100 pF Chip Capacitor, 0402 Pkg.	
С3	1000 pF Chip Capacitor, 0603 Pkg.	
C4	2.2 µF Capacitor, Tantalum	
L1	18 nH Chip Inductor, 0603 Pkg.	
R1	18 Ohm Resistor, 1210 1/8 watt Pkg.	
U1	HMC215LP4 / HMC215LP4E	
PCB [2]	113417 Evaluation Board	

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.